

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ)	
- 60	0.061 at V _{GS} = - 10 V	- 30	10	
- 00	0.072 at V _{GS} = - 4.5 V	- 25	10	

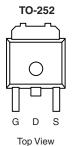
FEATURES

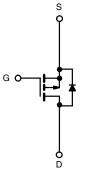
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch







P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current (T ₁ = 175 °C)	T _C = 25 °C	1-	- 30		
Continuous Drain Current (1j = 175°C)	T _C = 100 °C	ID —	- 25		
Pulsed Drain Current	I _{DM}	- 30	А		
Continuing Source Current (Diode Conduction)	۱ _S	- 20			
Avalanche Current	I _{AS}	- 20	1		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	7.2	mJ	
Menimum Denne Dissis sting	T _C = 25 °C	D	34 ^a	W	
Maximum Power Dissipation	T _A = 25 °C	P _D	4 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
hundling to Anching b	t ≤ 10 sec	D	20	25		
Junction-to-Ambient ^D	Steady State	R _{thJA}	62	75	°C/W	
Junction-to-Case		R _{thJC}	5	6		

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

SPECIFICATIONS $T_J = 25$		Test Conditions	Min	E und	Max	فأهال	
Parameter	Symbol	lest Conditions	Min	Тур ^а	Мах	Unit	
Static	N					1	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = - 250 μA	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1.0	- 2.0	- 3.0	· ·	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μΑ	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 175 °C			- 150		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 10			А	
		V _{GS} = - 10 V, I _D = - 5 A	0.061				
	-	V_{GS} = - 10 V, I _D = - 5 A, T _J = 125 °C		0.100		Ω	
Drain-Source On-State Resistance ^b	r _{DS(on)}	V_{GS} = - 10 V, I _D = - 5 A, T _J = 175 °C		0.150			
		V _{GS} = - 4.5 V, I _D = - 2 A		0.072			
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S	
Dynamic		• • •		4	·		
Input Capacitance	C _{iss}			1000		pF	
Output Capacitance	C _{oss}	$V_{DS} = -25 V$, $V_{GS} = 0 V$, f = 1 MHz		120			
Reverse Transfer Capacitance	C _{rss}			100			
Total Gate Charge	Qg			10			
Gate-Source Charge	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -8.4 \text{ A}$		2.1		nC	
Gate-Drain Charge	Q _{gd}			3.2		1	
Gate Resistance	R _g	f = 1 MHz		8.0		Ω	
Turn-On Delay Time ^c	t _{d(on)}			6			
Rise Time ^c	tr	V_{DD} = - 30 V, R_{L} = 3.57 Ω		15		1	
Turn-Off Delay Time ^c	t _{d(off)}	$\frac{t_{d(off)}}{t_{f}} I_{D} \cong -8.4 \text{ A}, \text{V}_{\text{GEN}} = -10 \text{ V}, \text{R}_{\text{G}} = 2.5 \Omega$		16		ns -	
Fall Time ^c	t _f			8			
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b					
Pulsed Current	I _{SM}				- 30	А	
Forward Voltage ^b	V _{SD}	$I_{F} = -2 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.9	- 1.3	V	
Reverse Recovery Time	t _{rr}			50		ns	
Reverse Recovery Time	Q _{rr}	I _F = - 8 A, di/dt = 100 A/μs		80		nC	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

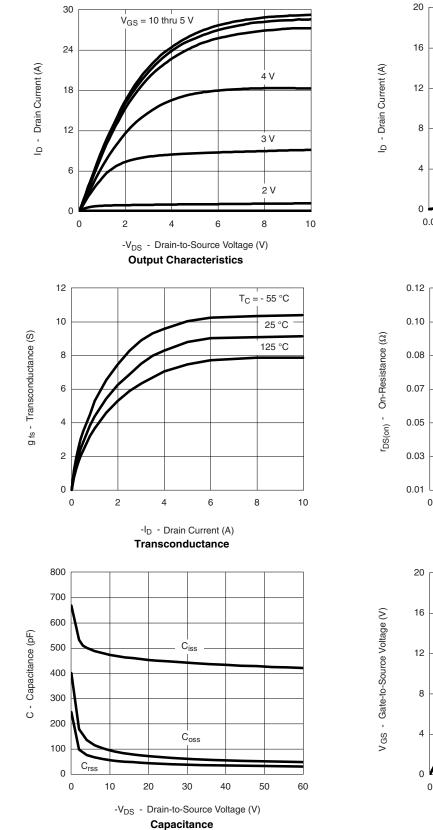
VBsemi VBsemi.com



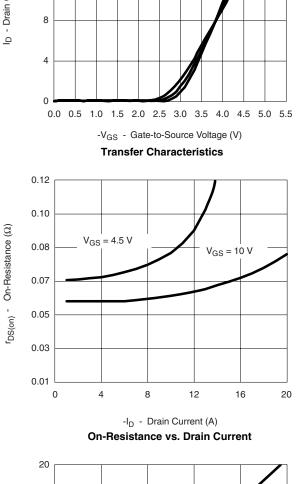
125 °C

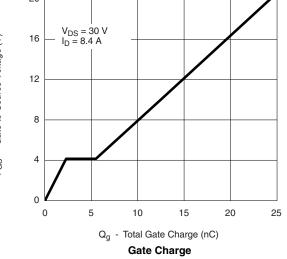
T_C = - 55 °C

1 25 °C



TYPICAL CHARACTERISTICS 25 °C unless noted



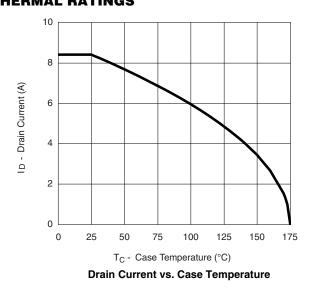


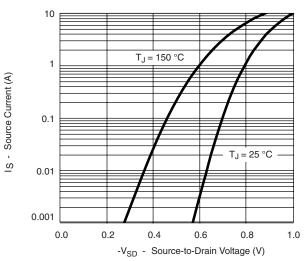


2.3 $V_{GS} = 10 V$ $I_D = 50 A$ 2.0 r_{DS(on)} - On-Resistance (Normalized) 1.7 1.4 1.1 0.8 0.5 - 50 0 25 50 75 100 125 150 175 - 25 T_J - Junction Temperature (°C) **On-Resistance vs. Junction Temperature**

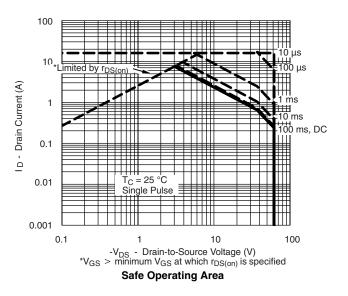
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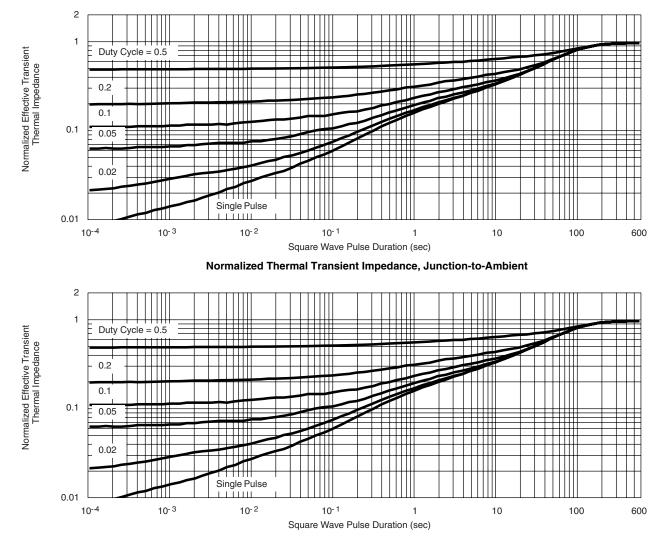




Source-Drain Diode Forward Voltage





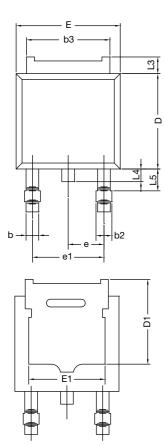


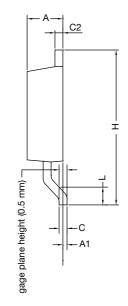
THERMAL RATINGS

Normalized Thermal Transient Impedance, Junction-to-Case



TO-252AA CASE OUTLINE





	MILLIN	IETERS	INC	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0 DWG: 5347	0247-Rev. M,	24-Dec-12			

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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